



NOTES:

1. MATERIAL:

- 1.1 HOUSING:HALOGEN FREE PLASTIC,HIGH TEMP; UL94V-0.
- 1.2 CONTACT:COPPER ALLOY.
- 1.3 FITTING NAIL: COPPER ALLOY

2.FINISH:

2.1 TERMINAL:

- 1:50u" MIN.NICKEL UNDERPLATING OVERALL. GOLD FLASH ON CONTACT AREA.
- T:50u" MIN.NICKEL UNDERPLATING OVERALL. 10u" MIN GOLD ON CONTACT AREA.
- D:50u" MIN.NICKEL UNDERPLATING OVERALL. 30u" MIN GOLD ON CONTACT AREA.
- W:50u" MIN.NICKEL UNDERPLATING OVERALL. 3u" MIN GOLD ON CONTACT AREA.

2.2 FITTING NAIL:

- 50u" MIN.NICKEL UNDERPLATING OVERALL.
- 100u" MIN. MATT TIN PLATING OVERALL.

3. SPEC. PLS. REFER TO SPEC-51269-XXXX-XXX

4. THE PACKING DRAWING PLS. REFER TO 51269-XXXX-XX-TRP OR 51269-XXXX-U-TRP

5. PRAT NO:

51269-XXX X X-XXX

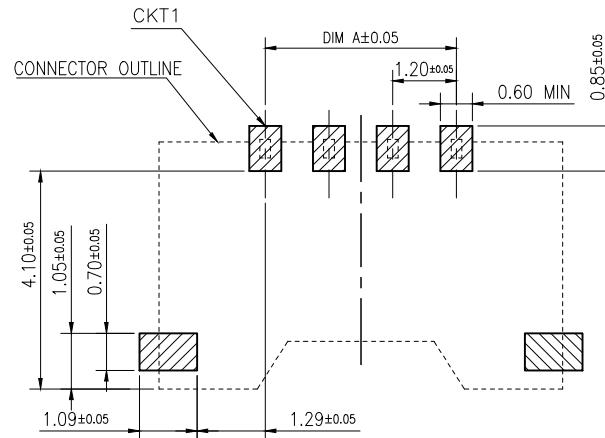
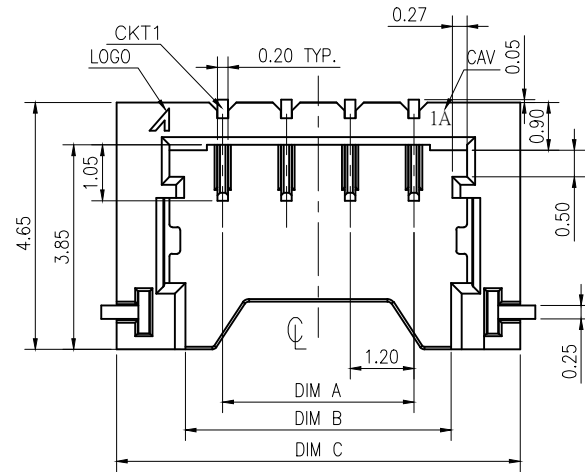
NO OF CKT

PACKING
0:TAPE & REEL

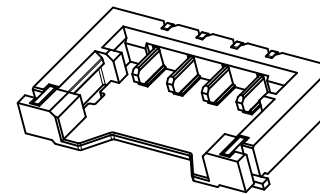
XXX	Halogen Free	PACKING
001	HF	51269-XXXX-XX-TRP
003	HF	51269-XXXX-U-TRP

PLATING

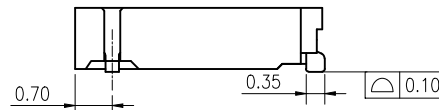
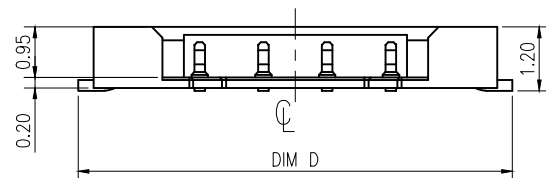
- 1: GOLD FLASH
- T: 10u" GOLD ON CONTACT
- D: 30u" GOLD ON CONTACT
- W: 3u" GOLD ON CONTACT



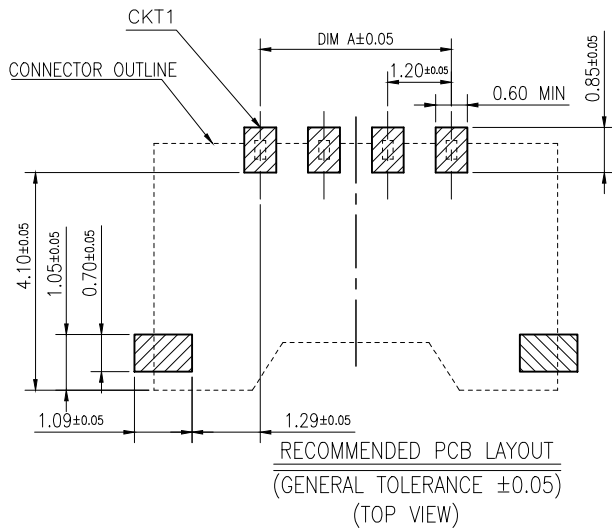
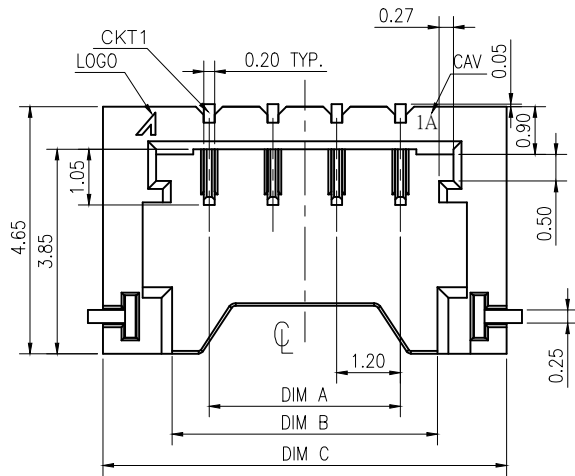
RECOMMENDED PCB LAYOUT
(GENERAL TOLERANCE ±0.05)
(TOP VIEW)



CKT	Dim A	Dim B	Dim C	Dim D
2	1.2	2.6	5.2	5.8
3	2.4	3.8	6.4	7.00
4	3.6	5.0	7.6	8.20
5	4.8	6.2	8.8	9.40
6	6.0	7.4	10.0	10.60
9	9.6	11.0	13.6	14.20

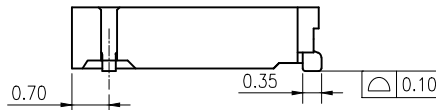
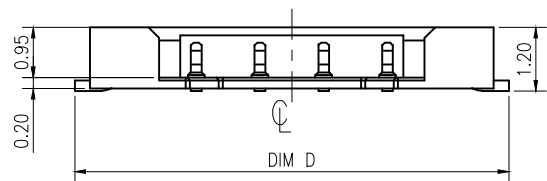
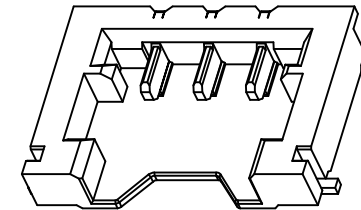


QUALITY SYMBOLS MAJOR Ⓜ CRITICAL Ⓢ	DRAWN BY SHISONGTAO	DATE 2020/04/09		
GENERAL TOLERANCES (UNLESS SPECIFIED)	CHECKED BY XUZHUYONG	DATE 2020/04/09		
X. ±0.5 .X ±0.25 .XX ±0.15 .XXX ±0.1 ANGLES ±2°	APPROVED BY XUZHUYONG	DATE 2020/04/09	TITLE 1.2mm PITCH WTB WAFER CONNECTOR	
	UNITS mm	SCALE 1:1	SIZE A4	RFC NO. N/A
	SHEET NO. 1 OF 2	REV J	DWG NO. 51269-XXXX-XXX	



- NOTES:
- MATERIAL:
 - HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP; UL94V-0.
 - CONTACT: COPPER ALLOY.
 - FITTING NAIL: COPPER ALLOY.
 - FINISH:
 - TERMINAL:
 - 50 μ MIN. NICKEL UNDERPLATING OVERALL. GOLD FLASH ON CONTACT AREA.
 - FITTING NAIL:
 - 50 μ MIN. NICKEL UNDERPLATING OVERALL. 100 μ MIN. MATT TIN PLATING OVERALL.
 - SPEC. PLS. REFER TO SPEC-51269-XXXX-XXX
 - THE PACKING DRAWING PLS. REFER TO 51269-XXXX-XX-TRP
 - PRAT NO:

51269-XXX	X	X-XXX	002
NO OF CKT		PLATING	
		1: GOLD FLASH	
		PACKING	
		0: TAPE & REEL	



CKT	Dim A	Dim B	Dim C	Dim D
3	2.4	3.8	6.4	7.00

QUALITY SYMBOLS MAJOR CRITICAL GENERAL TOLERANCES (UNLESS SPECIFIED) X. ±0.5 .X ±0.25 .XX ±0.15 .XXX ±0.1 ANGLES ±2°	DRAWN BY SHISONGTAO DATE 2020/04/09		
	CHECKED BY XUZHUYONG DATE 2020/04/09		TITLE 1.2mm PITCH WTB WAFER CONNECTOR
APPROVED BY XUZHUYONG DATE 2020/04/09	UNITS mm	SIZE A4	RFG NO. N/A
SCALE 1:1	SHEET NO. 2 OF 2	REV J	DWG NO. 51269-XXXXX-XXX

单击下面可查看定价，库存，交付和生命周期等信息

[>>ACES\(宏致\)](#)